FlashPRO: Flash Memory Engineering Programmer



Intel's FlashPRO base and socket module

upgrades provide system designers with an

efficient and cost-effective prototyping tool

Flash Memories. New devices are supported

upon their introduction via software upgrades.

for programming and erasing 5V-tolerant Intel

SOLUTIONS E V E R Y STEP OF THE WAY

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Updates are posted on Intel's World Wide Web site and Application Support BBS. With separately-available socket modules, you purchase only what you need. This keeps costs down while providing quick-turn support for future packages and pinouts. This tool is a significant enhancement to its predecessor, the D,FLASHEVAL kits, as it adds support for many new devices, is lower cost and higher performance.

PRODUCT DESCRIPTION

FlashPRO is a PC-driven (parallel port attachment) programmer. It enables system designers to program and erase all 5V-tolerant Intel DIP Flash Memory components directly. (Block locking support is available on required products.) Non-DIP packages require that one of the separately-available socket modules be used (please see ordering information on reverse).

Three family module boards come with the base tool and are another integral part of the system. They keep costs down by routing power and ground for device families via inexpensive circuit boards with SIMM-like connector edges. For example, the 56-lead TSOP module supports all current devices in that package type: 2/4-Mbit Boot Block devices, 16/32-Mbit FlashFile[™] memories and the 28F016XS and 28F016XD Fast Flash devices—even though their pinouts are drastically different.

The user's manual provides information on supported file formats, system requirements, menu commands, status and setting displays, buffer editor usage, use of the macro file iFLASH3.INI, troubleshooting tips and technical support contacts.

The iFLASH3 graphical interface is very user friendly. Current D,FLASHEVAL users will enjoy its similarity, providing a near-zero learning curve. On-line help guides users through the extensive tool capabilities without their having to access instruction manuals. Because of its intuitive menu structure and on-line help, even new users will be programming quickly.

PRODUCT HIGHLIGHTS

- Low-cost engineering programming solution
- Cost-effective modular support
 Buy only what you need
 - Each socket module supports all devices in that package via use of the family module boards
- Intuitive, easy-to-use menus
 Easy transition for existing D,FLASHEVAL users
- Socket modules for all packages
 - 56/48/40/32-lead TSOP 56/40-ball µBGA*
 - 32-lead PLCC
 - 68-pin PC Card
 - 60-pin Miniature Card¹

- 44-lead PSOP

- 72-lead SIMM

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- iFLASH3 software updates are maintained on Intel's World Wide Web site and Application Support BBS

¹ Requires FlashPROMEMCRD module and industry-standard Miniature Card-to-PC Card adapter (see reference on reverse side, under Support Tools heading, for availability of this adapter).

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| FEATURES | BENEFITS |
|--|--|
| Parallel-port attachment | Uses PC's resources—lowers base unit's cost |
| Family module boards | Socket modules support all device families in a given package—reduces number of upgrade pieces |
| iFLASH3 programming software | Similar to D,FLASHEVAL iFLASH2 software— near-zero learning curve |
| Intuitive user interface and on-line help | Ease of use—quicker time to programming |

SUPPORT TOOLS

The latest version of iFLASH3 software will be maintained on Intel's World Wide Web site under the developers area and on Intel's Application Support BBS under the Flash/Tools area.

Note: See "Miniature Card-to-PC Card Adapter Reference" via "By Device" or "By Tool Type" selection for Series 100 Miniature Cards at http://developer.intel.com/design/flcard/ devtools/ for a list of available suppliers.

Other Intel Flash Memory documents include:

- Flash Memory Tools and Software Quick Reference Guide (Lit. Order #297610)
- Small Outline Package Guide (Lit. Order #296514)

TOOL CONTENTS

Base Tool

- One (1) FlashPRO programmer
- Three (3) Power/GND Routing Boards
- One (1) User's Manual
- One (1) Quick Installation Guide
- One (1) 3.5" Floppy Disk with iFLASH3 Software
- One (1) Intel World Wide Web Brochure
- One (1) FlashPRO Product Brief
- One (1) Registration Card

Socket Modules

• One (1) Socket Adapter of type selected



TOOL ORDERING INFORMATION

| ORDER CODE | DESCRIPTION |
|----------------|--|
| FlashPRO | Base Programmer with 48-pin DIP ZIF socket |
| FlashPROMBGA40 | Socket Module for 40-ball µBGA devices |
| FlashPROMBGA56 | Socket Module for 56-ball µBGA devices |
| FlashPROTSOP32 | Socket Module for 32-lead TSOP devices |
| FlashPROTSOP40 | Socket Module for 40-lead TSOP devices |
| FlashPROTSOP48 | Socket Module for 48-lead TSOP devices |
| FlashPROTSOP56 | Socket Module for 56-lead TSOP devices |
| FlashPROPSOP44 | Socket Module for 44-lead PSOP devices |
| FlashPROSSOP56 | Socket Module for 56-lead SSOP devices |
| FlashPROPLCC32 | Socket Module for 32-lead PLCC devices |
| FlashPROSIMM72 | Socket Module for 72-lead SIMMs |
| FlashPROMEMCRD | Socket Module for 68-pin PC Card |

| INTEL ACCESS | | |
|--|--|--|
| World Wide Web Home Page | http://www.intel.com/ | |
| Application Bulletin Board System | (916) 356-3600 | |
| Other Intel Support: | | |
| Intel Literature Center | (800) 548-4725 7 a.m. to 7 p.m. CST (U.S. and Canada) International locations please contact your local sales office. | |
| Retail PC and Network Products | (800) 538-3373 or (503) 629-7000 7 a.m. to 7 p.m. PST | |
| General Information Hotline | (800) 628-8686 or (916) 356-3104 5 a.m. to 5 p.m. PST | |
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UNITED STATES

Intel Corporation 2200 Mission College Blvd. P.O. Box 58119 Santa Clara, CA 95052-8119 JAPAN I Intel Japan, K.K. I 5-6 Todokai, S Tsukuba-shi I Ibakari 300-26

FRANCE Intel Corporation S.A.R.L. 1, Rue Edison, BP 303 78054, Saint Quentinen-Yvelines Cedex UNITED KINGDOM Intel Corporation (U.K.) Ltd. Pipers Way, Swindon Wiltshire, England SN3 1RJ GERMANY Intel GmbH Dornacher Strasse 1 85622 Feldkirchen/Muenchen HONG KONG Intel Semiconductor Ltd. 32/F Two Pacific Place 88 Queensway

Central

CANADA

Intel Semiconductor of Canada, Ltd. 190 Attwell Drive, Suite 500 Rexdale, Ontario M9W 6H8